# **Surface Mount Schottky Power Rectifier**

# **SMA/SMB** Power Surface Mount Package

This device employs the Schottky Barrier principle in a metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes.

### **Features**

- Compact Package with J-Bend Leads Ideal for Automated Handling
- Highly Stable Oxide Passivated Junction
- Guard-Ring for Overvoltage Protection
- Low Forward Voltage Drop
- This is a Pb–Free Device

### **Mechanical Characteristics**

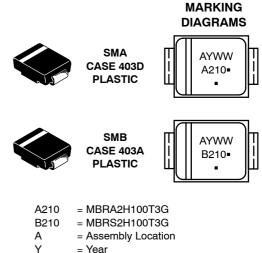
- Case: Molded Epoxy
- Epoxy Meets UL 94 V-0 @ 0.125 in
- Weight: 70 mg (SMA), 95 mg (SMB) (Approximately)
- Cathode Polarity Band
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- ESD Ratings: Machine Model = C, Human Body Model = 3B
- Device Meets MSL1 Requirements



# **ON Semiconductor®**

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# SCHOTTKY BARRIER RECTIFIER 2.0 AMPERES, 100 VOLTS



WW = Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MBRA2H100T3G	SMA (Pb-Free)	5000 / Tape & Reel
MBRS2H100T3G	SMB (Pb-Free)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	100	V
Average Rectified Forward Current $(T_L = 150^{\circ}C)$	lo	2.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	130	A
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C
Operating Junction Temperature (Note 1)	TJ	-65 to +175	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. The heat generated must be less than the thermal conductivity from Junction-to-Ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ .

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit	
Thermal Resistance, Junction-to-Lead (Note 2)	MBRA2H100 MBRS2H100	$\Psi_{JCL}$	14 12	°C/W
Thermal Resistance, Junction-to-Ambient (Note 2)	MBRA2H100 MBRS2H100	$R_{\thetaJA}$	75 71	°C/W
Thermal Resistance, Junction-to-Ambient (Note 3)	MBRA2H100 MBRS2H100	$R_{\thetaJA}$	275 230	°C/W

#### **ELECTRICAL CHARACTERISTICS**

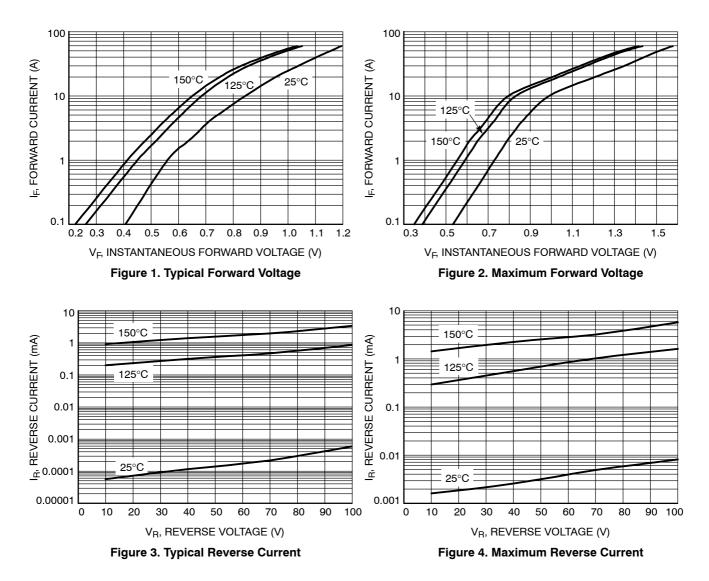
		Value		
Characteristic	Symbol	T <sub>J</sub> = 25°C	T <sub>J</sub> = 125°C	Unit
Maximum Instantaneous Forward Voltage (Note 4) (i <sub>F</sub> = 2.0 A	VF	0.79	0.65	V
Maximum Instantaneous Reverse Current (Note 4) (V <sub>R</sub> = 100 V	I <sub>R</sub>	0.008	1.5	mA

2. Mounted with 700 mm square copper pad size (Approximately 1 inch square) 1 oz FR4 Board.

3. Mounted with minimum recommended pad size 1 oz FR4 Board.

4. Pulse Test: Pulse Width  $\leq$  380  $\mu$ s, Duty Cycle  $\leq$  2.0%.

# **TYPICAL CHARACTERISTICS**



## **TYPICAL CHARACTERISTICS**

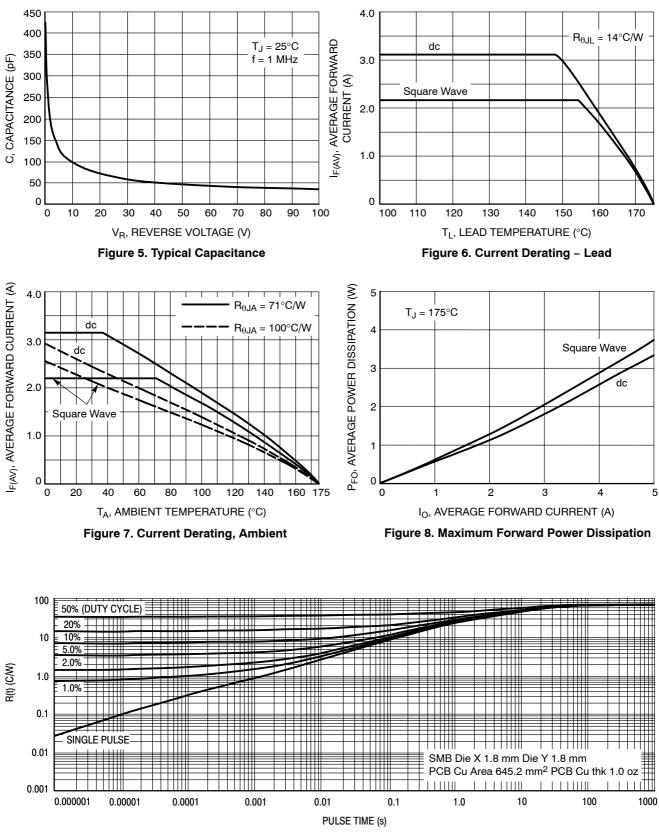
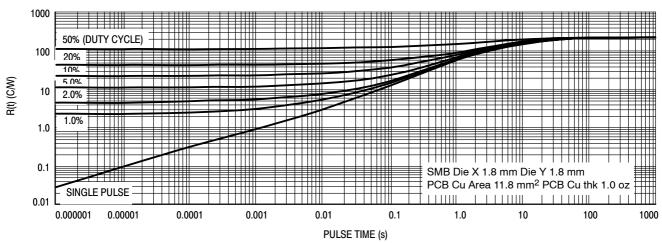
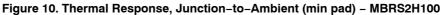


Figure 9. Thermal Response, Junction-to-Ambient (1 inch pad) - MBRS2H100

**TYPICAL CHARACTERISTICS** 





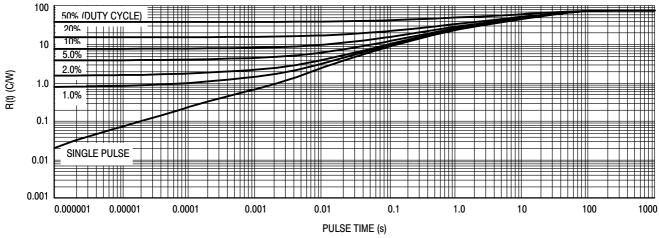


Figure 11. Thermal Response, Junction-to-Ambient (1 inch pad) – MBRA2H100

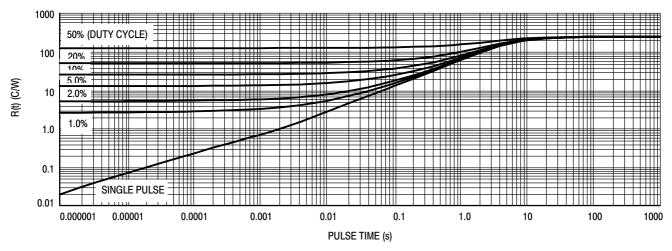


Figure 12. Thermal Response, Junction-to-Ambient (min pad) - MBRA2H100

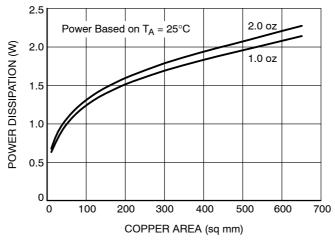
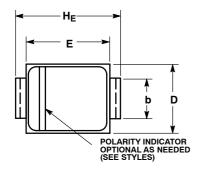


Figure 13. P<sub>D</sub>, Junction-to-Ambient (URS copper area)

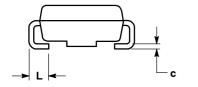
### PACKAGE DIMENSIONS

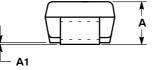
SMA CASE 403D-02 ISSUE F



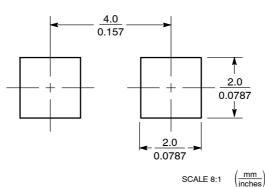
NOTES: NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. 403D-01 OBSOLETE, NEW STANDARD IS 403D-02.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	1.97	2.10	2.20	0.078	0.083	0.087
A1	0.05	0.10	0.15	0.002	0.004	0.006
b	1.27	1.45	1.63	0.050	0.057	0.064
с	0.15	0.28	0.41	0.006	0.011	0.016
D	2.29	2.60	2.92	0.090	0.103	0.115
E	4.06	4.32	4.57	0.160	0.170	0.180
HE	4.83	5.21	5.59	0.190	0.205	0.220
L	0.76	1.14	1.52	0.030	0.045	0.060





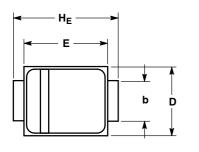
#### **SOLDERING FOOTPRINT\***

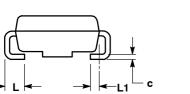


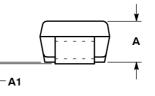
\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### PACKAGE DIMENSIONS

SMB CASE 403A-03 ISSUE G







NOTES:

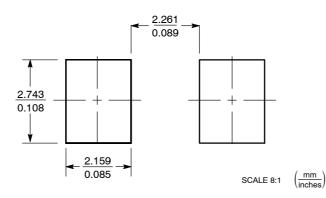
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

2. CONTROLLING DIMENSION: INCH.

3. D DIMENSION SHALL BE MEASURED WITHIN DIMENSION P.

	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	1.90	2.13	2.45	0.075	0.084	0.096	
A1	0.05	0.10	0.20	0.002	0.004	0.008	
b	1.96	2.03	2.20	0.077	0.080	0.087	
С	0.15	0.23	0.31	0.006	0.009	0.012	
D	3.30	3.56	3.95	0.130	0.140	0.156	
E	4.06	4.32	4.60	0.160	0.170	0.181	
HE	5.21	5.44	5.60	0.205	0.214	0.220	
L	0.76	1.02	1.60	0.030	0.040	0.063	
L1	0.51 REF			0.020 REF			

#### SOLDERING FOOTPRINT\*



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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